

OMNIMATE Power - series BV/SV 7.62HP SV-SMT 7.62HP/04/90G SC/6 2.6SN BX

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



OMNIMATE Power BV / SV 7.62HP Hybrid – for power, signals and EMC

Three functions in one!

The OMNIMATE Power Hybrid connector provides developers and users with the perfect three-in-one solution.

This hybrid motor connector simultaneously unites power, signals and pluggable EMC shield support. Thus you save space on the PCB, on the outer side of the housing, and in the electrical cabinet. The self-snapping one-handed interlock mechanism requires only one plugging step and thus speeds up installation and maintenance procedures. It is easy to handle and interlocks automatically – even in difficult installation positions. The unique shielding shape and slender 30° wire entry enable a space savings of up to 10 cm between rows.

General ordering data

| | |
|--------------|--|
| Type | SV-SMT 7.62HP/04/90G SC/6 2.6SN BX |
| Order No. | 2529090000 |
| Version | PCB plug-in connector, male header, closed side, THT/THR solder connection, 7.62 mm, Number of poles: 4, Solder pin length (l): 2.6 mm, tinned, black, Box |
| GTIN (EAN) | 4050118673159 |
| Qty. | 42 pc(s). |
| Product data | IEC: 1000 V / 41 A UL: 300 V / 33 A |
| Packaging | Box |

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Technical data**Dimensions and weights**

| | | | |
|--------------------------|------------|------------|---------|
| Height of lowest version | 11.4 mm | Depth | 28.3 mm |
| Depth (inches) | 1.114 inch | Net weight | 6.68 g |

System specifications

| Product family | OMNIMATE Power - series BV/SV 7.62HP | Type of connection | Board connection |
|---|---|---|---|
| Mounting onto the PCB | THT/THR solder connection | Pitch in mm (P) | 7.62 mm |
| Pitch in inches (P) | 0.3 inch | Number of poles | 4 |
| Number of solder pins per pole | 2 | Solder pin length (l) | 2.6 mm |
| Solder pin length tolerance | +0.1 / -0.3 mm | Solder pin dimensions | 0.8 x 1.0 mm |
| Solder eyelet hole diameter (D) | 1.4 mm | Solder eyelet hole diameter tolerance (D)+ | 0, 1 mm |
| L1 in mm | 22.86 mm | L1 in inches | 0.9 inch |
| Pin series quantity | 1 | Touch-safe protection acc. to DIN VDE 57 106 | safe to back of hand above the printed circuit board |
| Touch-safe protection acc. to DIN VDE 0470 | IP 20 | Volume resistance | 2.00 mΩ |
| Can be coded | Yes | Plugging cycles | 25 |
| Plugging force/pole, max. | 12 N | Pulling force/pole, max. | 7 N |

Material data

| | | | |
|---------------------------------------|-------------------------------|---------------------------------------|-------------------------------|
| Insulating material | PA GF HT3 | Colour | black |
| Colour chart (similar) | RAL 9011 | Insulating material group | II |
| Comparative Tracking Index (CTI) | ≥ 500 | Insulation strength | ≥ 10 ⁸ Ω |
| Moisture Level (MSL) | 3 | UL 94 flammability rating | V-0 |
| Contact material | Copper alloy | Contact surface | tinned |
| Layer structure of solder connection | 1-3 μm Ni / 4-6 μm Sn matt | Layer structure of plug contact | 1-3 μm Ni / 4-6 μm Sn matt |
| Storage temperature, min. | -25 °C | Storage temperature, max. | 50 °C |
| Max. relative humidity during storage | 70 % | Operating temperature, min. | -50 °C |
| Operating temperature, max. | 130 °C | Temperature range, installation, min. | -25 °C |
| Temperature range, installation, max. | 130 °C | | |

Rated data acc. to IEC

| | | | |
|--|------------------------|--|-------------------|
| tested acc. to standard | IEC 60664-1, IEC 61984 | Rated current, min. number of poles (Tu=20°C) | 41 A |
| Rated current, max. number of poles (Tu=20°C) | 41 A | Rated current, min. number of poles (Tu=40°C) | 41 A |
| Rated current, max. number of poles (Tu=40°C) | 41 A | Rated voltage for surge voltage class / pollution degree II/2 | 1,000 V |
| Rated voltage for surge voltage class / pollution degree III/2 | 630 V | Rated voltage for surge voltage class / pollution degree III/3 | 630 V |
| Rated impulse voltage for surge voltage class/ pollution degree II/2 | 6 kV | Rated impulse voltage for surge voltage class/ pollution degree III/2 | 6 kV |
| Rated impulse voltage for surge voltage class/ contamination degree III/3 | 6 kV | Short-time withstand current resistance | 3 x 1s with 420 A |

Rated data acc. to UL 1059

| | | | |
|---------------------------------------|--------|---------------------------------------|--------|
| Rated voltage (Use group B / UL 1059) | 300 V | Rated voltage (Use group C / UL 1059) | 300 V |
| Rated voltage (Use group D / UL 1059) | 600 V | Rated current (Use group B / UL 1059) | 33 A |
| Rated current (Use group C / UL 1059) | 33 A | Rated current (Use group D / UL 1059) | 5 A |
| Clearance distance, min. | 6.9 mm | Creepage distance, min. | 9.6 mm |

Creation date May 2, 2020 7:37:06 AM CEST

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Technical data
Packing

| | | | |
|-----------|-----|------------|---|
| Packaging | Box | VPE length | 0 |
| VPE width | 0 | VPE height | 0 |

Technical data - hybrid

| | | | |
|---|------------------|---|---------------------|
| Pitch in mm (Signal) | 3.81 mm | Pitch in inches (Signal) | 0.15 inch |
| Number of poles (Signal) | 6 | Number of solder pins per pole (Signal) | 1 |
| Solder pin dimensions (Signal) | 0.8 x 0.8 mm | PCB hole diameter (Signal) | 1.3 mm |
| PCB hole diameter tolerance (Signal) | ± 0.1 mm | L2 in mm | 11.43 mm |
| L2 in inch | 0.45 inch | Number of rows (Signal) | 2 |
| Contact material (Signal) | CuMg | Contact surface (Signal) | tinned |
| Rated voltage for overvoltage class/ pollution severity level II/2 (Signal) | 320 V | Rated voltage for overvoltage class/ pollution severity level III/2 (Signal) | 160 V |
| Rated voltage for overvoltage class/ pollution severity level III/3 (Signal) | 160 V | Rated impulse voltage for overvoltage class/pollution severity level II/2 (Signal) | 2.5 kV |
| Rated impulse voltage for overvoltage class/pollution severity level III/2 (Signal) | 2.5 kV | Rated impulse voltage for overvoltage class/pollution severity level III/3 (Signal) | 2.5 kV |
| Short-time withstand current resistance (Signal) | 3 x 1s with 80 A | Rated voltage (Use group B / CSA) (Signal) | 300 V |
| Rated voltage (Use group C / CSA) (Signal) | 50 V | Rated current (Use group B / CSA) (Signal) | 9 A |
| Rated current (Use group C / CSA) (Signal) | 9 A | Rated current (Use group D / CSA) (Signal) | 9 A |
| Rated voltage (Use group B / UL 1059) (Signal) | 300 V | Rated voltage (Use group C / UL 1059) (Signal) | 50 V factory wiring |
| Rated voltage (Use group D / UL 1059) (Signal) | 300 V | Rated current (Use group B / UL 1059) (Signal) | 5 A |
| Rated current (Use group C / UL 1059) (Signal) | 5 A | | |

Classifications

| | | | |
|-------------|-------------|------------|-------------|
| ETIM 6.0 | EC002637 | ETIM 7.0 | EC002637 |
| eClass 9.0 | 27-44-04-02 | eClass 9.1 | 27-44-04-02 |
| eClass 10.0 | 27-44-04-02 | | |

Notes

| | |
|----------------|--|
| Notes | <ul style="list-style-type: none"> • Technical specifications refer to the power contacts • Technical data of signal contacts: 50V / 5A, stripping length 8mm • Rated current related to rated cross-section & min. No. of poles. • Specifications of diagram: P1=7.62 mm; P2=3.81 mm • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. |
| IPC conformity | Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request. |

Data sheet**OMNIMATE Power - series BV/SV 7.62HP
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Technical data**Downloads**

White paper power electronics
connected correctly

[Download Whitepaper](#)

White paper UL 600 V

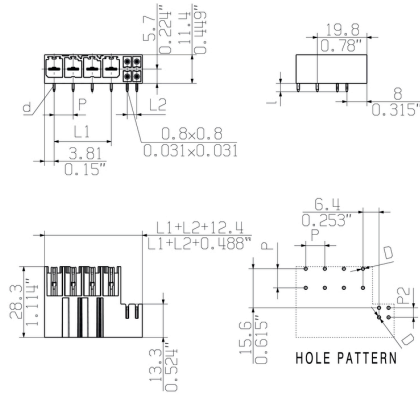
[Download Whitepaper](#)

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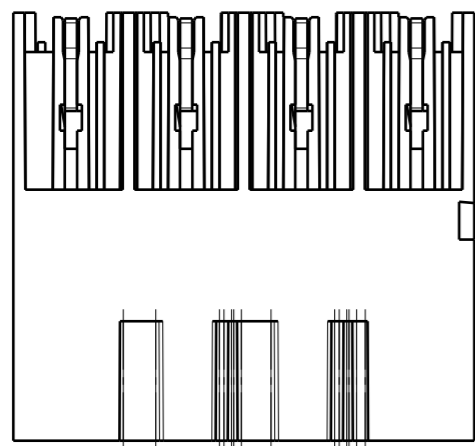
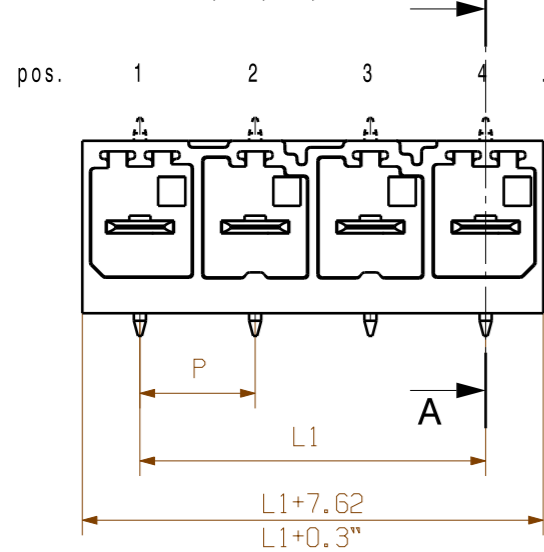
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Drawings

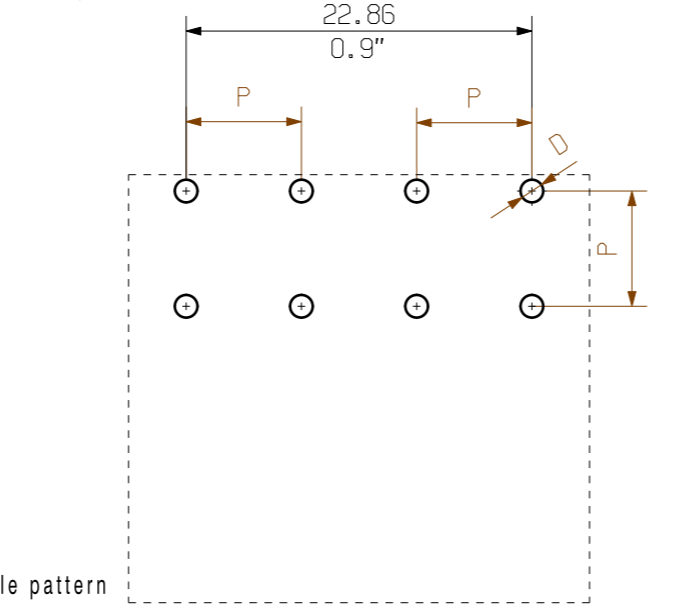
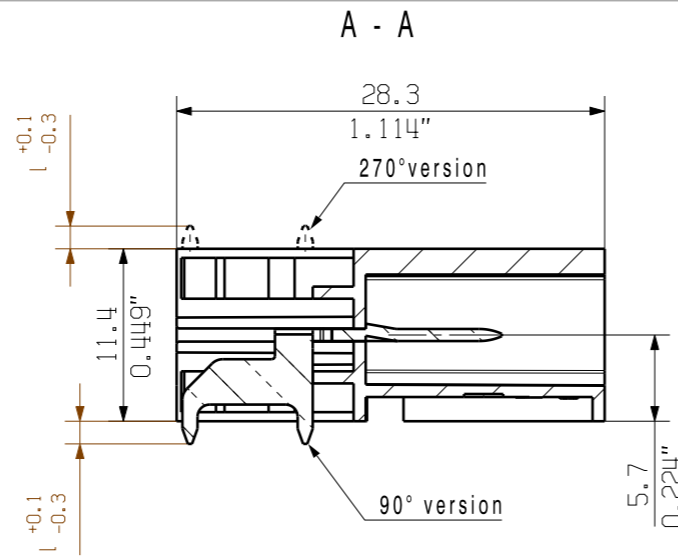
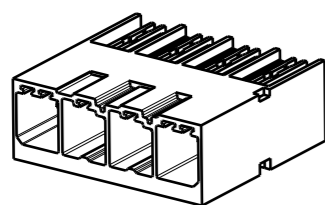
Dimensional drawing



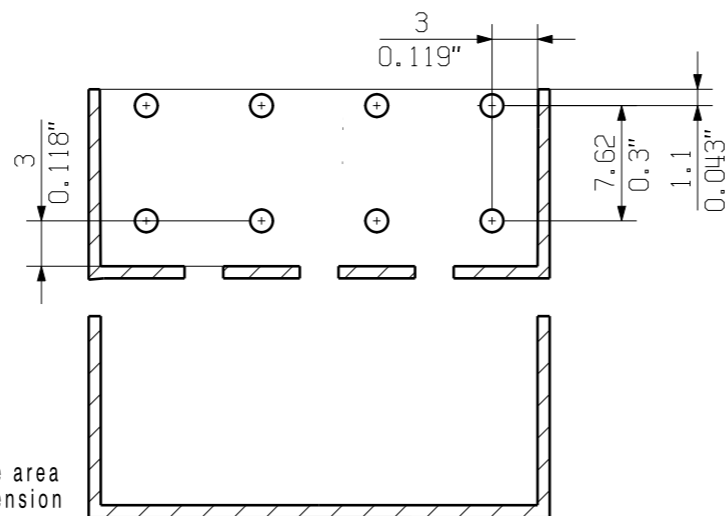
SV-SMT 7.62IT/04/90/270



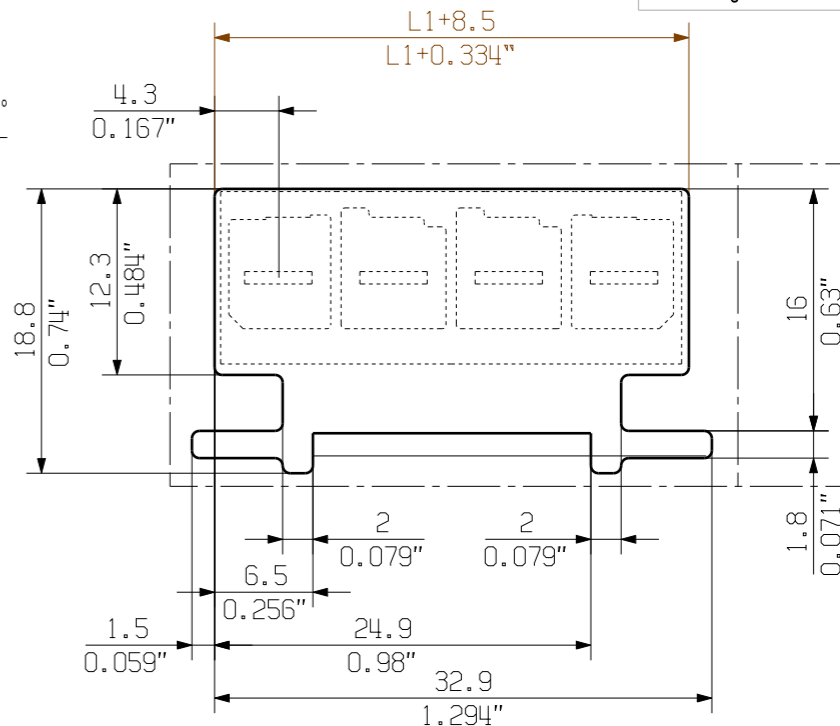
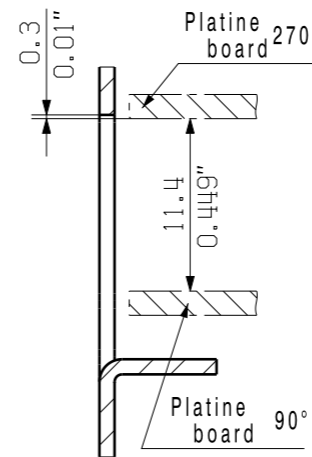
SV-SMT 7.62IT/04/90G
1:1



hole pattern



paste free area
max. dimension



D = Ø1.5+0.1/-0.05
d = 0.8x1.0

P = Raster /pitch

| | | |
|---|-------|-------|
| 9 | 60,96 | 68,58 |
| 8 | 53,34 | 60,96 |
| 7 | 45,72 | 53,34 |
| 6 | 38,1 | 45,72 |
| 5 | 30,48 | 38,1 |
| 4 | 22,86 | 30,48 |
| 3 | 15,24 | 22,86 |
| 2 | 7,62 | 15,24 |
| n | L1 | L2 |

| |
|------|
| 1.5 |
| 2.6 |
| 3.5 |
| l |
| [mm] |

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone. The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

GENERAL TOLERANCE:
DIN ISO 2768-m

| | | | | | |
|------------|--------------------------------|---------------------------|----------------|-------------------------------|---|
| | EC00001677 | Prim PLM Part No.: 114319 | | Prim ERP Part No.: 2454160000 | |
| | First Issue Date 14.11.2017 | Max. nos. | | | 66403 Drawing no. Issue no. Sheet 06 of 16 sheets |
| | Modification | | | | |
| | Drawn | Date | Name | | SV-SMT 7.62IT/./MF...RL STIFTLISTE MALE HEADER |
| | Responsible | 14.05.2019 | Helis, Maria | | |
| | Approved | 19.06.2019 | Krug, Matthias | | |
| Scale: 2:1 | Size: A3 | Approved | 19.06.2019 | Lang, Thomas | Product file: 7407 BLF 7.50HP |

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
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 Germany
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is ‚activated‘. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.